Monte Carlo Simulations for Applications in Electron Backscatter Diffraction.

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Electron Backscatter Diffraction (EBSD) in the scanning electron microscope (SEM) delivers important crystallographic information, which is contained in the Kikuchi patterns of backscattered electrons (BSE) near the incident energy E_0 . To describe details of of EBSD pattern generation, Monte Carlo (MC) simulations of the BSE energy spectrum can provide useful additional information. However, the need to correctly describe the low loss energy range near E_0 limits the applicability of the "continuous slowing down approximation" (CSDA) [1], often used to describe inelastic scattering in SEM MC simulations [2]. In contrast, simulations including discrete inelastic scattering processes based on the differential inverse inelastic mean free path (DIIMFP) have been successfully applied for the quantitative description of reflection energy loss spectroscopy (REELS) [1].

In order to compare both approaches, we carried out MC simulations for backscattering of E_0 =10keV electrons incident at 70° on a Si sample. In Fig. 1, we show the BSE spectra obtained using the CSDA in Casino 2.48 [2], and with discrete inelastic scattering using the REELS code from [7]. While both simulations result in a total integrated backscattering coefficient of η =0.6, the energy distributions near E_0 are drastically different. In contrast to the CSDA simulation, only the REELS simulation correctly reproduces the elastic backscattering peak at the primary beam energy, as well as the discrete plasmon loss features observed in energy resolved Kikuchi band measurements of Si [3].

In order to extract diffraction-relevant information from the MC results, we classify the electron trajectories into two groups. The first group ("localized BSE") has a "large-angle" scattering as the last elastic event, followed by at most n_{ie} inelastic events. These electrons are assumed to be scattered near an atomic nucleus, giving the crystal structure information in the EBSD pattern while all other types of trajectories are taken as originating on average from anywhere in a unit cell ("uniform BSE") and thus are assigned to a featureless background [4]. Here we take the limit of n_{ie} =0 (no inelastic scattering after the large angle event) which assumes that each inelastic event leads to total randomization of the scattering location within the crystal unit cell. The "large-angle" electron-atom scattering is defined as resulting in a transfer of recoil energy exceeding a critical value E_R , which is treated as a free parameter in this investigation. The resulting depth distributions for E_R =0.05eV are shown in Fig. 2. In this case, the distribution N(z) of the "localized BSE" (yellow) would contribute 8% to the total intensity and can be fitted by $N(z)=N_0\exp(z/\lambda)$ with a mean depth of $\lambda=12$ nm. For comparison, the gray histogram shows the maximum penetration depth z reached by the trajectories assigned to background electrons. In order to see the influence of the specific value of E_R , Table 1 summarizes results for 0.001eV $< E_R <$ 0.2eV. In all cases, the depth distribution of the localized BSE is well described by an exponential decay. For E_R =0.001eV and E_R =0.2eV, the localized fraction (determined by N_0) approaches the limits of a few percent compatible with signal-to-background ratios seen in experimental EBSD patterns. All in all, this enables us to estimate a depth sensitivity (λ) of EBSD from Si which is near 10 to 12nm for 10keV electrons in a typical geometry with 70 degree incidence angle. For 20kV electrons, we obtain a decay constant of about 22nm.

Our results can be interpreted by relatively simple models: Momentum transfer to atoms bound in a crystal is related to the physics of the Mössbauer effect [5], from which one expects that E_R should be of the order of representative phonon energies in the material (typically <100meV). The depth sensitivity in our model should be governed by the total inelastic mean free path, which is about 17nm for 10keV in Si [6]. The effective values of λ =10..12nm (measured along z) reflect the inclination of the exit paths of the BSE in experimental EBSD measurements. In future investigations, the incoherent source distributions obtained from a MC simulation will be included in dynamical electron diffraction calculations, which should provide an improved description of EBSD patterns, including the information which is present in the raw backscattered signal.

References:

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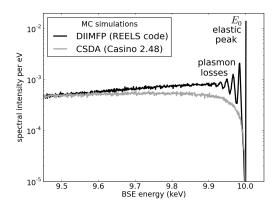
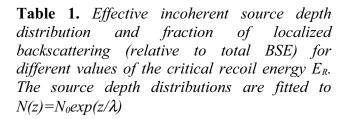


Figure 1. Simulated BSE spectra for Si, E_0 =10keV, 70° incidence. Integrated spectral intensity normalized to 1.0 for 50eV-10keV. For details see text.



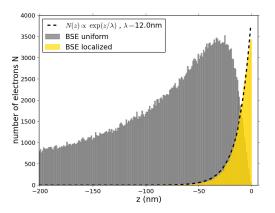


Figure 2. Yellow: Depth distribution of the "localized BSE" forming the Kikuchi pattern (dashed line: fit). Gray: Maximum z reached by "uniform BSE" in the featureless background.

critical recoil energy E _R (eV)	Mean source depth λ (nm)	Fraction of localized BSE
0.200	13.2	2%
0.100	12.4	5%
0.050	12.0	8%
0.010	9.6	19%
0.001	6.4	44%